# Advanced Hardware Hacking Techniques

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#### Agenda

- The "What" and "Why" of Hardware Hacking
- Enclosure & Mechanical Attacks
- Electrical Attacks
- Final Thoughts and Conclusions

# What is Hardware Hacking (to me)?

- Doing something with a piece of hardware that has never been done before
  - Personalization and customization (e.g., "hot rodding for geeks")
  - Adding functionality
  - Capacity or performance increase
  - Defeating protection and security mechanisms (**not** for profit)
- Creating something extraordinary
- Harming nobody in the process

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• Curiosity

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- To see how things work
- Improvement and Innovation
  - Make products better/cooler
  - Some products are sold to you intentionally limited or "crippled"
- Consumer Protection
  - I don't trust glossy marketing brochures...do you?

Hardware Security Myths

- Many security-related products rely on misconceptions to remain "secure"
- Hardware hacking is hard
- Consumers lack the competency or courage to void their warranty
- Therefore, hardware is "safe"

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# **Gaining Access to a Product**

- Purchase
  - Buy the product from a retail outlet (with cash)
- Evaluation
  - Rent or borrow the product
- Active
  - Product is in active operation, not owned by attacker
- Remote Access
  - No physical access to product, attacks launched remotely
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#### **Enclosure & Mechanical Attacks**

- Opening Housings
- External Interfaces

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- Anti-Tamper Mechanisms
- Conformal Coating and Epoxy Encapsulation Removal

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Opening Housings
Goal is to get access to internal circuitry
Usually as easy as loosening some screws or prying open the device







- Security bits and one-way screws
  - Used to prevent housings from being easily opened
  - Ex.: Bathroom stalls, 3.8mm and 4.5mm security bit for Nintendo and Sega game cartridges/systems
     To identify a particular bit type, visit
  - www.lara.com/reviews/screwtypes.htm
  - Bits available at electronics stores, swapmeets, online





- Wireless interfaces also at risk (though not discussed here)
  - Ex.: 802.11b, Bluetooth
- Any interface that connects to a third-party may contain information that is useful for an attack
   Could possibly obtain data, secrets, etc.

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#### **External Interfaces 2**

- Look for obfuscated interfaces
  - Ex.: Proprietary or out-of-the-ordinary connector types, hidden access doors or holes
- Many times, test points just hidden by a sticker



#### **External Interfaces 3**

- Use multimeter or oscilloscope to probe and determine functionality
  - Logic state of pins can help with an educated guess
  - Ex.: Pull pins high or low, observe results, repeat
- Monitor communications using H/W or S/W-based protocol analyzer
  - USB: SnoopyPro

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- RS232 and parallel port: PortMon
- Send intentionally malformed/bad packets to cause a fault
  - If firmware doesn't handle this right, device could
  - trigger unintended operation useful for an attack

# **External Interfaces: Backdoors**

- Architecture-specific debug and test interfaces (usually undocumented)
- Diagnostic serial ports
  - Provides information about system, could also be used for administration
  - Ex.: Intel NetStructure crypto accelerator administrator access [1]
- Developer's backdoors
  - Commonly seen on networking equipment, telephone switches
  - Ex.: Palm OS debug mode [2]
- 15 Ex.: Sega Dreamcast CD-ROM boot





- Five connections (4 required, 1 optional):
  - ← TDO = Data Out (from target device)
  - → TDI = Data In (to target device)
  - $\rightarrow$  TMS = Test Mode Select

- → TCK = Test Clock
- $\rightarrow$  /TRST = Test Reset (optional)
- H/W interface to PC can be built with a few dollars of off-the-shelf components
  - EX.: www.lart.tudelft.nl/projects/jtag, http://jtag-arm9.sourceforge.net/circuit.txt, OF ftp://www.keith-koep.com/pub/arm-tools/jtag/ jtag05\_sch.pdf





- Primary facet of physical security for embedded systems
- Attempts to prevent unauthorized physical or electronic tampering against the product
- Most effectively used in layers
- Possibly bypassed with knowledge of method
- Purchase one or two devices to serve as "sacrificial lambs"

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**Anti-Tamper Mechanisms 2** 

- Tamper Resistance
  - Specialized materials used to make tampering difficult
  - Ex.: One-way screws, epoxy encapsulation, sealed housings
- Tamper Evidence
  - Ensure that there is visible evidence left behind by tampering
  - Only successful if a process is in place to check for deformity
  - Ex.: Passive detectors (seals, tapes, glues), special enclosure finishes (brittle packages, crazed aluminum, bleeding paint)

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### **Anti-Tamper Mechanisms 3**

- Tamper Detection
  - Enable the hardware device to be aware of tampering
  - Switches: Detect the opening of a device, breach of security boundary, or movement of a component
  - Sensors: Detect an operational or environmental change
  - Circuitry: Detect a puncture, break, or attempted modification of the security envelope

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- Tamper Response
  - Countermeasures taken upon the detection of tampering
  - Ex.: Zeroize critical memory, shutdown/disable/destroy device, enable logging features
- Physical Security Devices for Computer Subsystems [3] provides comprehensive attacks and countermeasures
  - Ex.: Probing, machining, electrical attacks, physical barriers, tamper evident solutions, sensors, response technologies

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- Encapsulation used to protect circuitry from moisture, dust, mold, corrosion, or arcing
- Epoxy or urethane coatings leave a hard, difficult to remove film



# Conformal Coating and Epoxy Encapsulation Removal 2

- The good news: The coatings are not specifically designed for security
  - Can usually be bypassed with special chemicals like MG Chemicals' 8310 Conformal Coating Stripper (www.mgchemicals.com)
- Brute force approach: Dremel tool and wooden skewer as a drill bit
  - Doesn't damage the components underneath coating
  - Might remove the soldermask, but not a big deal...

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- Surface Mount Devices
- Probing Boards
- Memory and Programmable Logic
- Chip Delidding and Die Analysis
- Emissions and Side-Channel Attacks
- Clock and Timing

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#### **Surface Mount Devices**

- Harder to work with than through-hole devices
   Ex.: Fine-pitched packages, tiny discrete components
  - Don't get discouraged
- Human hands have more resolution than the naked eye can resolve
  - A microscope can go a long way to solder components
- Circuit Cellar, July 2004: Build your own computer-controlled, temperature-adjusting SMT oven





# **Probing Boards**

- Look for test points and exposed traces/bus lines
- Surface mount leads and points are usually too small to manually probe
- Many ways to access:
  - Solder probe wire onto board using microscope
  - Use an SMD micrograbber (\$5-\$50)
  - Use a probe adapter (> \$100) from
  - www.emulation.com, www.ironwoodelectronics.com, OF www.advintcorp.com

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- Build your own probe

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- Most memory is notoriously insecure
  - Not designed with security in mind
  - Serial EEPROMs can be read in-circuit, usually SPI or  $\ensuremath{\mathsf{I}}^2C$  bus (serial clock and data) [5]
- Difficult to securely and totally erase data from RAM and non-volatile memory [6]
  - Remnants may exist and be retrievable from devices long after power is removed
  - Could be useful to obtain program code, temporary data, crypto keys, etc.

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# Memory and Programmable Logic 2

- SRAM-based FPGAs most vulnerable to attack
  - Must load configuration from external memory
  - Bit stream can be monitored to retrieve entire configuration
- To determine PLD functionality, try an I/O scan attack
  - Cycle through all possible combinations of inputs to determine outputs

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# Memory and Programmable Logic 3

- · Security fuses and boot-block protection
  - Enabled for "write-once" access to a memory area or to prevent full read back
  - Usually implemented in any decent design
  - Might be bypassed with die analysis attacks (FIB) or electrical faults [7]
  - Ex.: PIC16C84 attack in which security bit is removed by increasing VCC during repeated write accesses

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# **Chip Decapping and Die Analysis 2**

- The good thing is that IC designers make mistakes, so tools are needed
  - Failure analysis
  - Chip repair and inspection
- What tools?
  - Chip Decappers
  - Scanning Electron Microscope (SEM)
  - Voltage Contrast Microscopy
  - Focused Ion Beam (FIB)

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#### **Chip Decapping and Die Analysis 3**

- Equipment available on the used/surplus market
- Access to tools in most any large academic institution
- Reverse engineering and analysis services exist (still high priced, \$10k-\$20k)
  - Can provide functional investigation, extraction, IC simulation, analyze semiconductor processes, etc.
  - Ex.: Semiconductor Insights (www.semiconductor.com) and Chipworks (www.chipworks.com)

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### Emissions and Side-Channel Attacks: Power Supply

- Simple Power Analysis (SPA)
  - Attacker directly observes power consumption
  - Varies based on microprocessor operation
  - Easy to identify intensive functions (cryptographic)
- Differential Power Analysis (DPA) [12]
  - Advanced mathematical methods to determine secret information on a device

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# **Clock and Timing**

- Attacks rely on changing or measuring timing characteristics of the system
- Active (Invasive) timing attacks
  - Vary clock (speed up or slow down) to induce failure or unintended operation
- Passive timing attacks
  - Non-invasive measurements of computation time
  - Different tasks take different amounts of time
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- Intentionally messy/lousy code
- Spurious and meaningless data ("signal decoys")

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#### **Hardware Hacking Challenges**

- Advances in chip packaging
  - Ultra-fine pitch and chip-scale packaging (e.g., BGA, COB, CIB)
  - Not as easy to access pins/connections to probe

- Discrete components can now easily be inhaled

- Highly-integrated chips (sub-micron)
  - Difficult, but not impossible, to probe and modify
- · High speed boards
  - Processor and memory bus > hundreds of MHz
  - Serial bus speeds approaching Gigabit/sec.

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- · Cost of equipment
  - Advanced tools still beyond the reach of average hobbyist (probing, decapping, SEMs, etc.)
  - "State of the art" defined by what hackers can find in the trash and at swapmeets
- · Societal pressures
  - Hardware hacking is practically mainstream, but "hacker" is still a naughty word

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#### Conclusions

- Hardware hacking is approaching a mainstream
   activity
- Plays an important role in the balance between consumers and corporations (e.g., The Man)
- Think as a designer would
- Nothing is ever 100% secure
   Given enough time, resources, and motivation, you can break anything
- The possibilities are endless
- Have fun!
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#### **Appendix A: Additional Resources**

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R.G. Johnston and A.R.E. Garcia, "Vulnerability Assessment of Security Seals", Journal of Security Administration, 1997, www.securitymanagement.com/ library/lanl\_00418796.pdf •

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### **Appendix B: Related Web Sites**

- Cambridge University Security Group TAMPER Laboratory, www.cl.cam.ac.uk/Research/Security/tamper ٠
- •
- Molecular Expressions: Chip Shots Gallery, http://microscopy.fsu.edu/chipshots/index.html
- Bill Miller's CircuitBending.com, http://billtmiller.com/circuitbending • Virtual-Hideout.Net, www.virtual-hideout.net •
- LinuxDevices.com The Embedded Linux Portal, www.linuxdevices.com
- Roomba Community Discussing and Dissecting the Roomba, www.roombacommunity.com .
- •
- TiVo Techies, www.tivotechies.com

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#### **Appendix C: Tools of the Warranty Voiding Trade**

- Bright overhead lighting or desk lamp
- Protective gear (mask, goggles, rubber gloves, smock, etc.)
- ESD protection (anti-static mat and wriststrap)
- Screwdrivers
- X-ACTO hobby knife
- Dremel tool
- Needle file set ٠

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# Appendix C: Tools of the Warranty Voiding Trade 2

- Wire brushes
- Sandpaper
- Glue
- Tape
- Cleaning supplies
- Variable-speed cordless drill w/ drill bits
- Heat gun and heat-shrink tubing
- Center punch
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Appendix C: Tools of the Warranty Voiding Trade 3

- Nibbling tool
- Jigsaw
- Wire stripper/clipper
- Needle-nose pliers
- Tweezers
- Soldering iron w/ accessories (solder sucker, various tips, etc.)
- Basic electronic components

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# Appendix C: Tools of the Warranty Voiding Trade 4

• Microscope

- Digital and analog multimeters
- Adjustable power supply
- Device programmer
- UV EPROM eraser
- PCB etching kit
- Oscilloscope
- Logic Analyzer

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# Appendix D: Where to Obtain the Tools

- The Home Depot (www.homedepot.com)
- Lowe's (www.lowes.com)
- Hobby Lobby (www.hobbylobby.com)
- McMaster-Carr (www.mcmaster.com)
- Radio Shack (www.radioshack.com)
- Digi-Key (www.digikey.com)
- Contact East (www.contacteast.com)
- Test Equity (www.testequity.com)

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